05-18-1999 FORM PTO-1595 Patent and Trademark Office 1-31-92 7217/54372 To the Honorable Commissioner of Patents and 101040332 documents or copy thereof. 2. Name and address of receiving party(ies): 1. Name of conveying party(ies): Name: Sony Corporation AKIRA INOUE mRD 5-10-99 Internal Address: Additional name(s) of conveying party(ies) attached? Yes No 3. Nature of Conveyance: Street Address: 7-35 Kitashinagawa 6-chome X Assignment Shinagawa-ku, Tokyo, Japan Change of Name Security Agreement Additional name(s) & address(es) attached? Yes No U Other__ Execution Date: APRIL 13,1999 4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: A. Patent Application No.(s) B. Patent No.(s) 08/951,028 Filed October 15, 1997 Yes X No Additional numbers attached? 5. Name and address of party to whom correspondence 6. Total number of applications and patents involved: 1 concerning document should be mailed: Jay H. Maioli, Esq. 7. Total fee (37 CFR 3.41):. \$ __40.00 Internal Address: Cooper & Dunham LLP **Enclosed** Street Address: 1185 Avenue of the Americas Authorized to be charged to deposit accou 8. Deposit account number: City: New York State: New York ZIP 10036 03-3125 (Attach duplicate copy of this page if paying by deposit account) DO NOT USE THIS SPACE 9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Jay H. Maioli Name of Person Signing Total Number of pages comprising cover sheet: OMB No. 0651-0011 (exp. 4/94) Do not detach this portion Mail documents to be recorded with required cover sheet information to: Commissioner of Patents and Trademarks

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ASSIGNMENT

WHEREAS, I, as below named inventor, residing at the address stated next to my name, am a joint inventor of certain inventions relating to a <u>SPEECH ENCODING METHOD</u>

AND APPARATUS AND AUDIO SIGNAL ENCODING METHOD AND APPARATUS, for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation with offices at 6-7-35 Kitashinagawa, Shinagawa-Ku, Tokyo 141, Japan, (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereof;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

PATENT REEL: 9945 FRAME: 0072 And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereof;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow:

Serial No. 08/951,028 filed October 15, 1997

This assignment executed on the date indicated below.

AKIRA INOUE	Apr. 13, 1998
Name of joint inventor	Execution date of U.S. Patent Application
1-19-14-101 Kitasenzoku Ota-Ku,	Tokyo, Japan 145-0062
Residence of joint inventor	
Mira clasue	Apr. 13 , 1899
Signature of joint inventor	Date of this assignment

RECORDED: 05/10/1999

PATENT REEL: 9945 FRAME: 0073